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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Application No. : 10/581,500

Applicant : OKADA, MASUAKI

Filed : June 2, 2006

Title : BONDING METHOD, DEVICE FORMED BY SUCH METHOD,

SURFACE ACTIVATING UNIT AND BONDING APPARATUS

COMPRISING SUCH UNIT

Art Unit Examiner

: To Be Assigned: To be Assigned

Atty Docket No.

YANE-0004-US1

Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

The below-identified communication(s) is (are) submitted in the above-captioned application or proceeding:

Supplemental Application Data Sheet

The Commissioner is hereby authorized to charge payment of any fees associated with this communication, including fees under 37 C.F.R. §§ 1.16 and 1.17 or credit any

overpayment to Deposit Account Number 10-0233-YANE-0004-US1.

Respectfully submitted,

Ajay A. Jagtiani

My ME

Registration Number 35,205

JAGTIANI + GUTTAG Democracy Square Business Center 10363-A Democracy Lane Fairfax, Virginia 22030 (703) 591-2664

June 30, 2006

Supplemental on Data Sheet

Application Information

Application Type:: Regular Subject Matter:: Utility

Suggested classification:: Suggested Tech. Center:: CD-ROM or CD-R?:: Number of CD disks:: Number of Copies of CDs::

Sequence Submission::

Computer Readable Form (CRF)::

Number of copies of CRF::

Title Line One:: Bonding Method, Device Formed By Such Title Line Two:: Method, Surface Activating Unit And Bonding

Apparatus Comprising Such Unit Title Line Three::

YANE-0004-US1 Docket Number::

Request for Early Publication:: No Request for Non-publication:: No Suggested Drawing Figure:: **42 Total Drawing Sheets::** 13 Small Entity:: No

Latin name::

Variety denomination name::

Petition included?:: No

Petition Type::

Licensed US Govt. Agency:: Contract or Grant Numbers One:: Contract or Grant Numbers Two::

Secrecy Order in Parent Appl.:: No

Applicant Information

Applicant One Authority Type:: Inventor

Primary Citizenship Country:: JP

Status :: **Full Capacity** Given Name:: Masuaki

Middle Name::

OKADA Family Name::

Name Suffix::

City of Residence:: Osaka

State or Prov. of Residence::

Country of Residence:: JP

Mailing Address Line One:: 279-1-510, Fukaisawa-machi,

Mailing Address Line Two:: Sakai-shi City of Mailing Address:: Osaka

State or Province of Mailing Address::

Country of Mailing Address:: JP

Postal or Zip Code of Mailing Address:: 5998236

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Correspondence Information

Correspondence Customer Number::

22,506

Name:: Jagtiani + Guttag

Street of mailing address:: 10363-A Democracy Lane

City of mailing address:: Fairfax State or Province mailing address:: VA Country of mailing address:: US

Postal or Zip Code of mailing address:: 22030

Phone Number:: 703-591-2664 Fax Number:: 703-591-5907 E-Mail Address:: mail@jagtiani.com

Representative Information

22,506 Representative Customer Number::

Domestic Priority Information

Application:: This application	Continuity Type:: National Stage of	Parent Application:: PCT/JP2004/017934	Parent Filing Date:: 12-02-2004

Foreign Application Information

Country::	Application number::	Filing Date::	Priority Claimed::
JP	2003-402526	12-02-2003	Yes
JP	2004-069865	03-12-2004	Yes
JP	2004-069866	03-12-2004	Yes

Assignee Information

Assignee name:: Bondtech, Inc.

Street of mailing address one::Keihanna Plaza Labo-to, 1-7, Hikari-dai,

Street of mailing address two:: Seika-cho, Soraku-gun

City of mailing address::Kyoto

State or Province of mailing address::

Country of mailing address::JP

Postal or Zip Code of mailing address::6190237